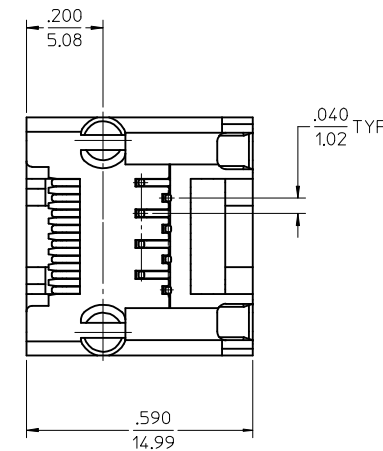
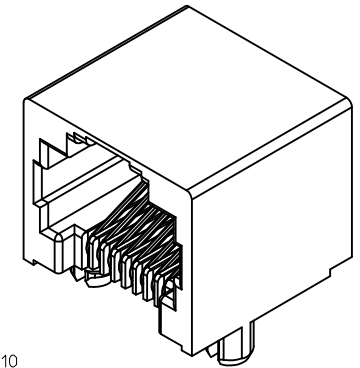
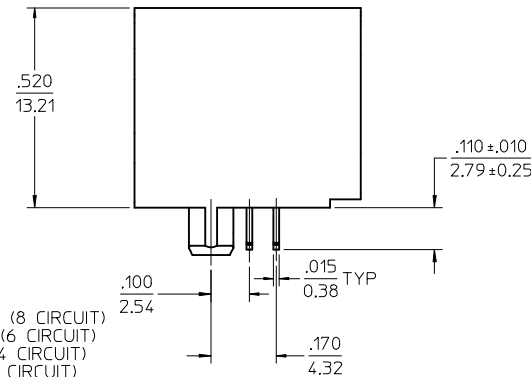
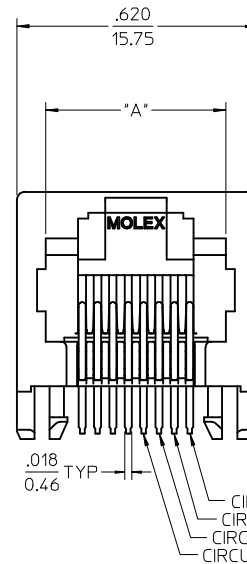
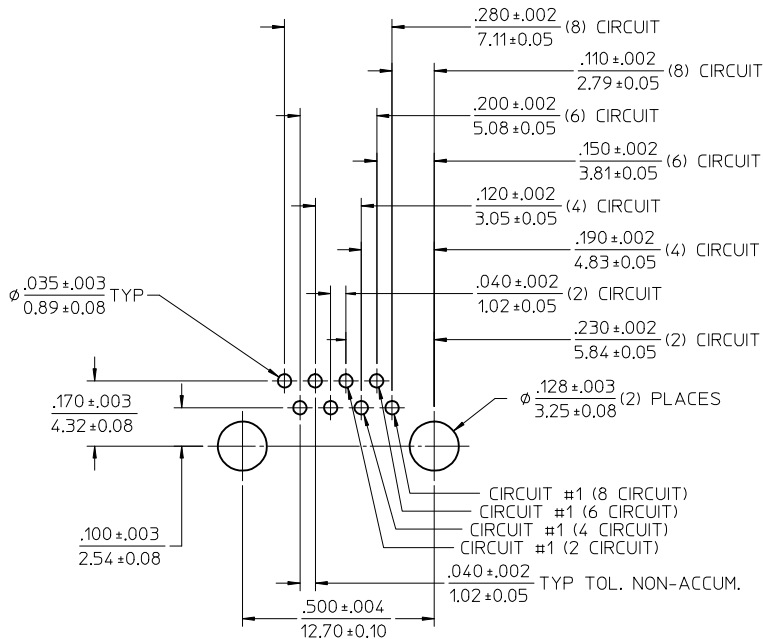


NOTES:

- 1) MATERIAL:
HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE CHART
TERMINALS: PHOSPHOR BRONZE
- 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO
RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE
2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT
WITH TIN-LEAD IN THE PC TAILS.
- 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
- 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES PACKAGED IN EXTRUDED TUBES PER MOLEX
PACKAGING SPECIFICATION PK-43860-004.
- 5) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- 6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
- 7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



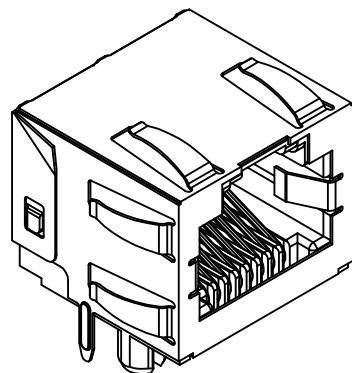
ASSEMBLY MAT. NUM.	CONNECTOR SIZE	DIM "A"	CIRCUITS	HOUSING COLOR
43860-0001	8	.469/11.91	8	BLACK
43860-0002	6	.389/9.88	6	BLACK
43860-0003	6	.389/9.88	4	BLACK
43860-0019	8	.469/11.91	4	BLACK
43860-0020	6	.389/9.88	2	BLACK

REV	DESCRIPTION	QUALITY SYMBOLS
REMOVE .080 OPTION		
EC NO: UCP2013-1054		
2012/09/12		
DRWN:BBEE		
2012/09/13		
CHKD:JBELL		
2012/09/14		
APPR:FSMTH		
H7		

GENERAL TOLERANCES (UNLESS SPECIFIED)
4 PLACES ± ---
3 PLACES ± ---
2 PLACES ± 0.25
1 PLACE ± ---
ANGULAR ± 1/2°
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

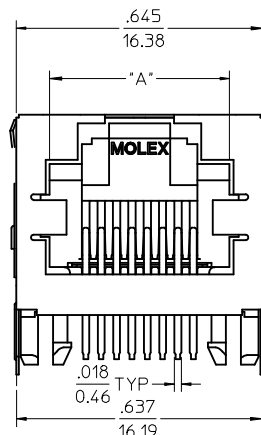
DIMENSION STYLE IN/MM
DRAWN BY DATE
CHECKED BY DATE
APPROVED BY DATE
MATERIAL NO.
SEE CHART
SIZE

SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
TITLE	INVERTED MODULAR JACK ASSEMBLY	
DOCUMENT NO.	MOLEX INCORPORATED	
SD-43860-001		
SHEET NO.	1 OF 5	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

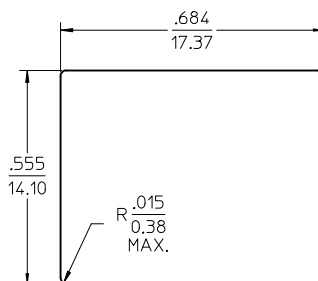


NOTES:

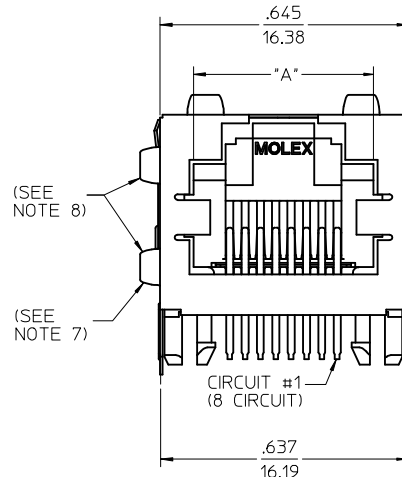
- 1) MATERIAL:
HOUSING: NYLON(PA), GLASS FILLED, UL94V-0,
COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
- 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES/
1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES/
2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES/
1.27 MICROMETERS MIN.,
SHIELD:
*100 MICROINCHES/2.54 MICROMETERS NICKEL OVER
50 MICROINCHES/1.27 MICROMETERS COPPER
UNDERPLATE, PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED
"COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND
ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN
PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.
- 3) PRODUCT SPECIFICATION: PS-43860-003.
- 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43860-005.
43860-5025 CONNECTOR ASSEMBLIES PACKAGED IN TAPE AND
REEL PER MOLEX PACKAGING SPECIFICATION PK-70873-700*
- 5) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- 6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
- 7) AVAILABLE WITH THE (2) SPECIFIED PANEL GROUND TABS
OMITTED FOR SIDE TO SIDE STACKABILITY, PER THE ASSEMBLY
MATERIAL NUMBER TABLE.
- 8) AVAILABLE WITH TOP PANEL GROUND TABS ONLY, PER THE
ASSEMBLY MATERIAL NUMBER TABLE.
- 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



NO PANEL
GROUND TABS

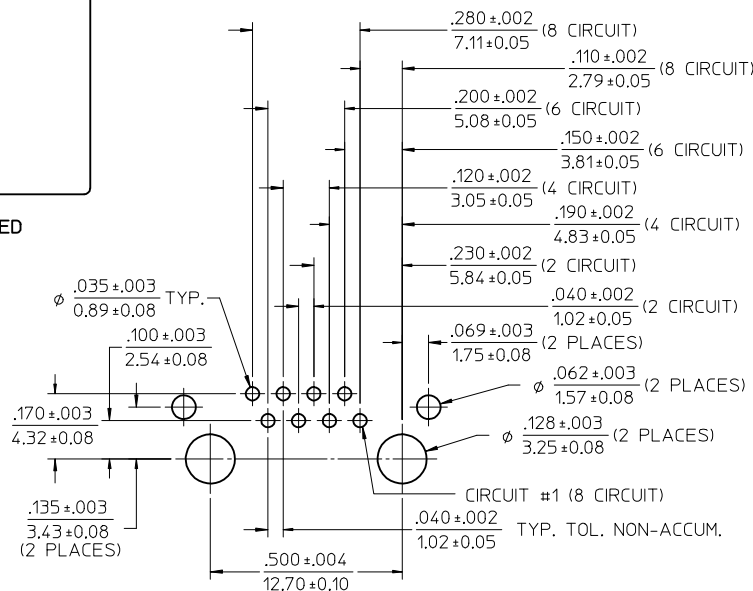
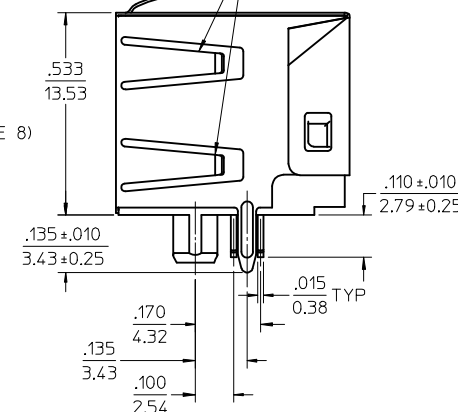


RECOMMENDED
PANEL
OPENING

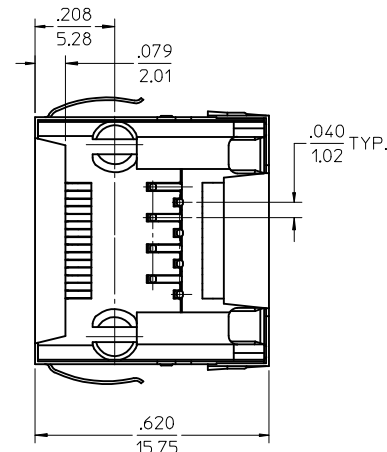


OPTIONAL PANEL
GROUND TAB
(SEE NOTE 7)

PANEL GROUND TABS



PC BOARD LAYOUT
COMPONENT SIDE OF BOARD
RECOMMENDED PCB THICKNESS .062±.005/1.57±.013



ASSEMBLY MAT. NUM.	CONNECTOR SIZE	DIM "A"	CIRCUITS	PANEL GROUND TABS	PACKAGING OPTION
43860-0004	8	.469/11.91	8	ALL	TRAY
43860-0005	6	.389/9.88	6	ALL	TRAY
43860-0006	6	.389/9.88	4	ALL	TRAY
43860-0013	8	.469/11.91	8	SEE NOTE #7	TRAY
43860-0014	6	.389/9.88	6	SEE NOTE #7	TRAY
43860-0015	6	.389/9.88	4	SEE NOTE #7	TRAY
43860-0024	6	.389/9.88	2	ALL	TRAY
43860-0025	8	.469/11.91	8	NONE	TRAY
43860-0026	6	.389/9.88	6	NONE	TRAY
43860-0027	6	.389/9.88	4	NONE	TRAY
43860-0031	8	.469/11.91	8	SEE NOTE #8	TRAY
43860-5025	8	.469/11.91	8	NONE	TAPE

SEE SHEET 1
EC NO: UCP2013-1054
2012/09/12
DRWN:BBEE
CHKD:JBELL
2012/09/13
APPR:FSM/TH
2012/09/14
REV
H7

QUALITY
SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES ±	---	---
3 PLACES ±	---	±.010
2 PLACES ±	0.25	---
1 PLACE ±	---	---

ANGULAR ±1/2°

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
IN/MM

DRAWN BY	DATE
TALEND	1997/02/13
CHECKED BY	DATE
ROBERTS	1997/03/03
APPROVED BY	DATE
FRY	1997/03/04

MATERIAL NO.
SEE CHART

SCALE
4:1

DESIGN UNITS
INCH

THIRD ANGLE
PROJECTION

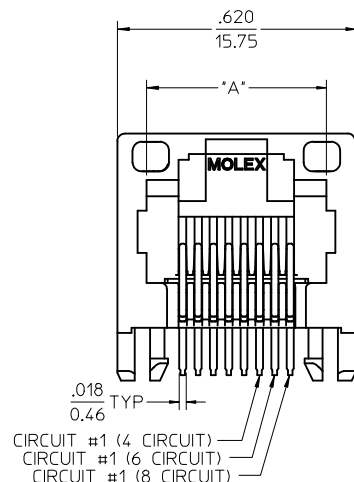
INVERTED MODULAR JACK
ASSEMBLY

MOLEX INCORPORATED

DOCUMENT NO.
SD-43860-001

SHEET NO.
2 OF 5

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION



NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK

TERMINALS: PHOSPHOR BRONZE

LIGHT PIPES:

POLYCARBONATE - WAVE OR HAND SOLDER ONLY
(NOT DESIGNED FOR I/R REFLOW OR
CONVECTION REFLOW SOLDER PROCESSES)

POLYSULFONE - MAXIMUM REFLOW TEMPERATURE 400°F (205°C)

2) FINISH:

TERMINALS:

SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.,

*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.,

WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.

*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO
RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE
2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT
WITH TIN-LEAD IN THE PC TAILS.

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.

4) PACKAGING SPECIFICATION:

CONNECTOR ASSEMBLIES PACKAGED IN EXTRUDED TUBES PER MOLEX
PACKAGING SPECIFICATION PK-43860-004.

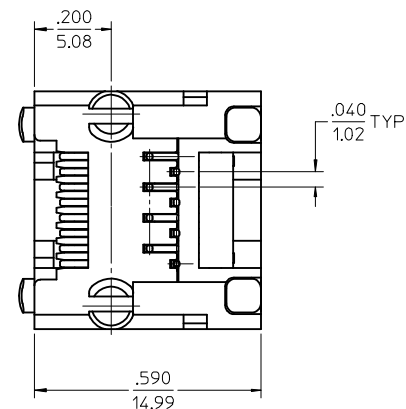
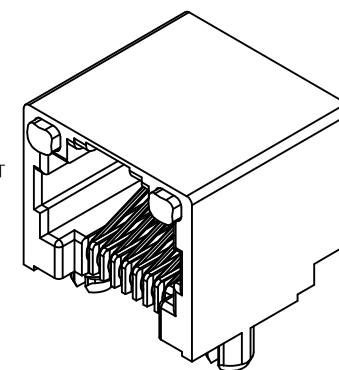
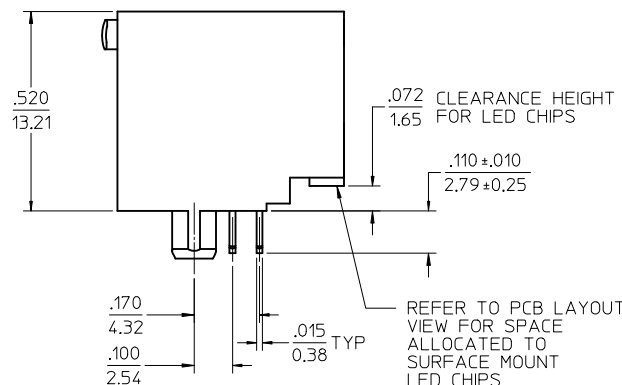
5) APPLICATION SPECIFICATION: AS-43860-001

6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.

7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

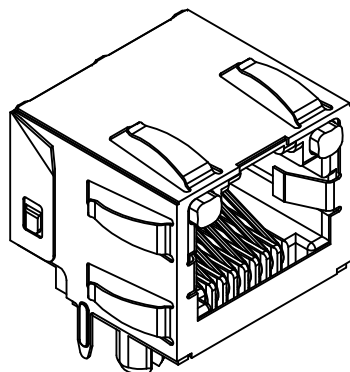
8) REFER TO SHEET (5) OF (5) FOR RECOMMENDED PCB LAYOUT.

9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

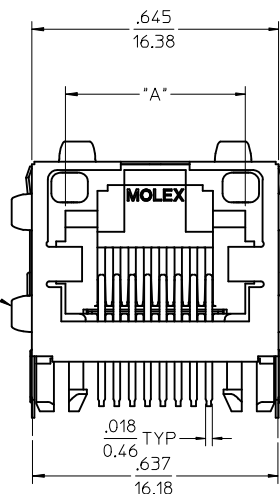


ASSEMBLY MAT. NUM.	LIGHT PIPE MATERIAL	CONNECTOR SIZE	DIM "A"	CIRCUITS
43860-0007	POLYCARBONATE	8	.469/11.91	8
43860-0008	POLYCARBONATE	6	.389/9.88	6
43860-0009	POLYCARBONATE	6	.389/9.88	4
43860-0021	POLYSULFONE	8	.469/11.91	8
43860-0022	POLYSULFONE	6	.389/9.88	6
43860-0023	POLYSULFONE	6	.389/9.88	4

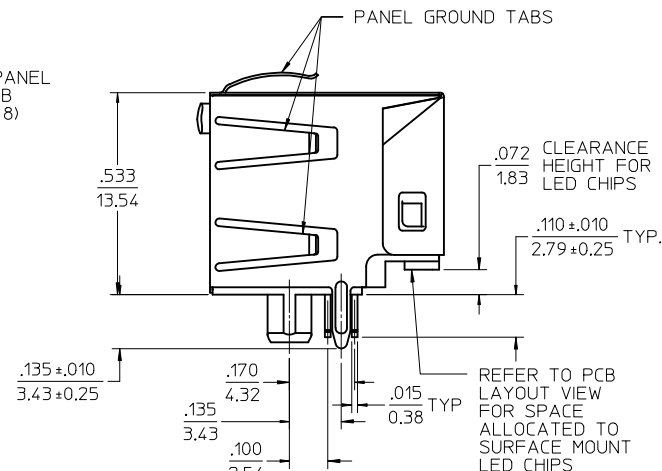
SEE SHEET 1 EC NO: UCP2013-1054 2012/09/12 DRWN:BBEE CHKD:JBELL 2012/09/13 APPR:FSMITH 2012/09/14	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION		
				mm	INCH	DRAWN BY TALEND	DATE 1997/02/13	TITLE INVERTED MODULAR JACK ASSEMBLY MOLEX INCORPORATED SD-43860-001	SHEET NO. 3 OF 5		
			4 PLACES	± ---	± ---	CHECKED BY ROBERTS	DATE 1997/03/03				
			3 PLACES	± ---	± .010	APPROVED BY	DATE				
			2 PLACES	± 0.25	± ---	FRY	1997/03/04				
			1 PLACE	± ---	± ---	MATERIAL NO. SEE CHART					
ANGULAR ±1/2°			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MOLEX INCORPORATED		DOCUMENT NO. SD-43860-001				
H7			SIZE			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



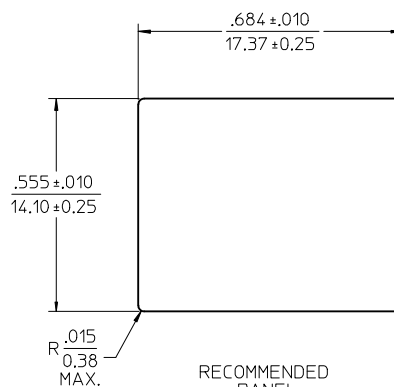
OPTIONAL PANEL
GROUND TAB
(SEE NOTE 8)



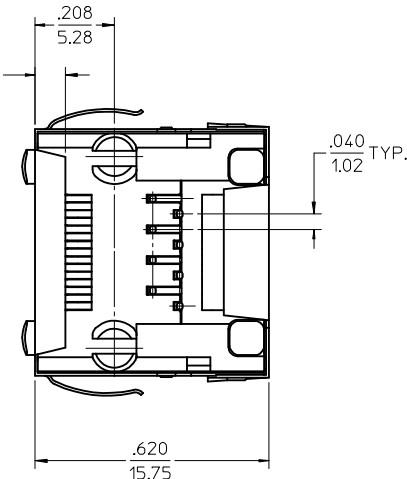
OPTIONAL PANEL
GROUND TAB
(SEE NOTE 8)



REFER TO PCB
LAYOUT VIEW
FOR SPACE
ALLOCATED TO
SURFACE MOUNT
LED CHIPS



RECOMMENDED
PANEL
OPENING



NOTES:

- 1) MATERIAL:
HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
LIGHT PIPES:
POLYCARBONATE - WAVE OR HAND SOLDER ONLY
(NOT DESIGNED FOR I/R REFLOW OR
CONVECTION REFLOW SOLDER PROCESSES)
POLYSULFONE - MAXIMUM REFLOW TEMPERATURE 400°F (205°C)
- 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES/1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES/2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES/1.27 MICROMETERS MIN.
SHIELD:
*100 MICROINCHES/2.54 MICROMETERS OVER 50 MICROINCHES/1.27
MICROMETERS COPPER UNDERPLATE, PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN
THE PC TAILS AND/OR SHIELD.
- 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
- 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS PER MOLEX
PACKAGING SPECIFICATION PK-43860-005.
- 5) APPLICATION SPECIFICATION: AS-43860-001
- 6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- 7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
- 8) AVAILABLE WITH THE (2) SPECIFIED PANEL GROUND TABS OMITTED FOR SIDE
TO SIDE STACKABILITY, PER THE ASSEMBLY MATERIAL NUMBER TABLE.
- 9) REFER TO SHEET (5) OF (5) FOR RECOMMENDED PCB LAYOUT.
- 10) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

ASSEMBLY MAT. NUM.	LIGHT PIPE MATERIAL	CONNECTOR SIZE	DIM "A"	CIRCUITS	PANEL GROUND TABS
43860-0010	POLYCARBONATE	8	.469/11.91	8	ALL
43860-0011	POLYCARBONATE	6	.389/9.88	6	ALL
43860-0012	POLYCARBONATE	6	.389/9.88	4	ALL
43860-0016	POLYCARBONATE	8	.469/11.91	8	SEE NOTE #8
43860-0017	POLYCARBONATE	6	.389/9.88	6	SEE NOTE #8
43860-0018	POLYCARBONATE	6	.389/9.88	4	SEE NOTE #8
43860-1010	POLYSULFONE	8	.469/11.91	8	ALL
43860-1011	POLYSULFONE	6	.389/9.88	6	ALL
43860-1012	POLYSULFONE	6	.389/9.88	4	ALL
43860-1016	POLYSULFONE	8	.469/11.91	8	SEE NOTE #8
43860-1017	POLYSULFONE	6	.389/9.88	6	SEE NOTE #8
43860-1018	POLYSULFONE	6	.389/9.88	4	SEE NOTE #8

SEE SHEET 1
EC NO: UCP2013-1054
2012/09/12
DRWN:BEE
2012/09/13
CHKD:JELL
2012/09/14
APPR:FSMITH

QUALITY
SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES ± ---	± ---	± ---
3 PLACES ± ---	± .010	± ---
2 PLACES ± .25	± ---	± ---
1 PLACE ± ---	± ---	± ---

ANGULAR ±1/2°

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
IN/MM

DRAWN BY	DATE
TALEND	1997/02/13
CHECKED BY	DATE
ROBERTS	1997/03/03
APPROVED BY	DATE
FRY	1997/03/04

MATERIAL NO.
SEE CHART

SIZE
C

SCALE
4:1

DESIGN UNITS
INCH

THIRD ANGLE
PROJECTION

INVERTED MODULAR JACK
ASSEMBLY

MOLEX INCORPORATED

DOCUMENT NO.
SD-43860-001

SHEET NO.
4 OF 5

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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Email: org@lifeelectronics.ru

www.lifeelectronics.ru